



## Material Content Data Sheet



<b>Sales Product Name</b>				SAL-TC299TP-128F300N BC		<b>Issued</b>		12. August 2019	
<b>MA#</b>				MA001648352					
<b>Package</b>				PG-LFBGA-516-5		<b>Weight*</b>		1987.14 mg	
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	36.614	1.84	1.84	18425	18425	
wire	noble metal	palladium	7440-05-3	0.023	0.00		12		
	non noble metal	copper	7440-50-8	2.326	0.12	0.12	1171	1183	
encapsulation	organic material	carbon black	1333-86-4	1.679	0.08		845		
	plastics	epoxy resin	-	115.872	5.83		58311		
	inorganic material	silicondioxide	60676-86-0	722.103	36.35	42.26	363387	422543	
substrate	inorganic material	bariumsulfate	7727-43-7	23.317	1.17		11734		
	non noble metal	metal hydroxide	-	26.895	1.35		13535		
	plastics	acrylic resin	-	26.985	1.36		13580		
	inorganic material	amorphous silica	7631-86-9	53.790	2.71		27069		
	plastics	epoxy resin	-	95.881	4.83		48251		
	inorganic material	glass fibre wool	65997-17-3	107.581	5.41		54138		
	non noble metal	copper	7440-50-8	517.918	26.06	42.89	260634	428941	
plating	noble metal	gold	7440-57-5	0.489	0.02		246		
	non noble metal	nickel	7440-02-0	1.337	0.07	0.09	673	919	
solderball	noble metal	silver	7440-22-4	8.700	0.44		4378		
	non noble metal	tin	7440-31-5	239.863	12.07	12.51	120707	125085	
glue	plastics	epoxy resin	-	1.443	0.07		726		
	noble metal	silver	7440-22-4	4.328	0.22	0.29	2178	2904	
*deviation	< 10%					Sum in total:	100.00		1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com